

## **MOSFET**

### OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V

### **Features**

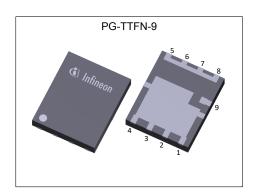
- N-channel, normal level
- Very low on-resistance R<sub>DS(on)</sub>
   Superior thermal resistance
- 100% avalanche tested
- Pb-free lead plating; RoHS compliant
  Halogen-free according to IEC61249-2-21

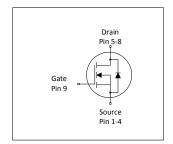
### **Product validation**

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters** 

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Parameter	Value	Unit						
$V_{ t DS}$	100	V						
R <sub>DS(on),max</sub>	2.05	mΩ						
<b>I</b> <sub>D</sub>	273	A						
Qoss	125	nC						
<b>Q</b> <sub>G</sub>	107	nC						











Type / Ordering Code	Package	Marking	Related Links
IQD020N10NM5CG	PG-TTFN-9	02010NC	-

# OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V



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# OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V IQD020N10NM5CG



# 1 Maximum ratings at $T_A$ =25 °C, unless otherwise specified

Table 2 **Maximum ratings** 

Damanatan	Ol	Values				
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current <sup>1)</sup>	I <sub>D</sub>	- - -	- - -	273 193 158 26	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =6 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =50°C/W <sup>2)</sup>
Pulsed drain current <sup>3)</sup>	I <sub>D,pulse</sub>	-	-	1092	Α	<i>T</i> <sub>C</sub> =25 °C
Avalanche energy, single pulse <sup>4)</sup>	<b>E</b> AS	-	-	756	mJ	$I_{\rm D}$ =50 A, $R_{\rm GS}$ =25 $\Omega$
Gate source voltage	V <sub>GS</sub>	-20	-	20	V	-
Power dissipation	P <sub>tot</sub>	-	-	333 3.0	W	T <sub>C</sub> =25 °C T <sub>A</sub> =25 °C, R <sub>thJA</sub> =50 °C/W <sup>2)</sup>
Operating and storage temperature $T_{j}$ , $T_{stg}$		-55	-	175	°C	-

#### 2 Thermal characteristics

#### Table 3 Thermal characteristics

Darameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R <sub>thJC</sub>	-	-	0.45	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area <sup>2)</sup>	R <sub>thJA</sub>	-	-	50	°C/W	-

<sup>&</sup>lt;sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.  $^{2)}$  Device on 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm $^{2}$  (one layer, 70  $\mu$ m thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

# OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V IQD020N10NM5CG



### **Electrical characteristics**

at T<sub>j</sub>=25 °C, unless otherwise specified

**Static characteristics** Table 4

D	0		Value	S	1114	N 4 7 4 0 114	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V <sub>(BR)DSS</sub>	100	-	-	V	V <sub>GS</sub> =0 V, I <sub>D</sub> =1 mA	
Gate threshold voltage	V <sub>GS(th)</sub>	2.2	3.0	3.8	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 159  \mu {\rm A}$	
Zero gate voltage drain current	I <sub>DSS</sub>	-	0.1 10	1 100	μΑ	V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =25 °C V <sub>DS</sub> =100 V, V <sub>GS</sub> =0 V, T <sub>j</sub> =125 °C	
Gate-source leakage current	I <sub>GSS</sub>	-	10	100	nA	V <sub>GS</sub> =20 V, V <sub>DS</sub> =0 V	
Drain-source on-state resistance	R <sub>DS(on)</sub>	-	1.8 2.2	2.05 2.75	mΩ	V <sub>GS</sub> =10 V, I <sub>D</sub> =50 A V <sub>GS</sub> =6 V, I <sub>D</sub> =25 A	
Gate resistance	R <sub>G</sub>	-	0.58	-	Ω	-	
Transconductance	<b>g</b> fs	80	160	-	S	$ V_{DS}  \ge 2 I_D R_{DS(on)max}, I_D = 50 A$	

Table 5 **Dynamic characteristics** 

Parameter	Ob. a.l.	Values				
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance <sup>1)</sup>	C <sub>iss</sub>	-	7300	9500	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Output capacitance <sup>1)</sup>	Coss	-	1000	1300	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Reverse transfer capacitance <sup>1)</sup>	C <sub>rss</sub>	-	42	74	pF	V <sub>GS</sub> =0 V, V <sub>DS</sub> =50 V, f=1 MHz
Turn-on delay time	t <sub>d(on)</sub>	-	15	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Rise time	t <sub>r</sub>	-	6	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Turn-off delay time	$t_{ m d(off)}$	-	28	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$
Fall time	t <sub>f</sub>	-	7	-	ns	$V_{\rm DD}$ =50 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =50 A, $R_{\rm G,ext}$ =1.6 $\Omega$

Gate charge characteristics<sup>2)</sup> Table 6

Parameter	Values			6	l lmi4	Nata / Tast Candition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q <sub>gs</sub>	-	32	-	nC	V <sub>DD</sub> =50 V, I <sub>D</sub> =50 A, V <sub>GS</sub> =0 to 10 V
Gate charge at threshold	$Q_{g(th)}$	-	22	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge <sup>1)</sup>	$Q_{\mathrm{gd}}$	-	23	35	nC	V <sub>DD</sub> =50 V, I <sub>D</sub> =50 A, V <sub>GS</sub> =0 to 10 V
Switching charge	Q <sub>sw</sub>	-	33	-	nC	$V_{\rm DD}$ =50 V, $I_{\rm D}$ =50 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total <sup>1)</sup>	Qg	-	107	134	nC	V <sub>DD</sub> =50 V, I <sub>D</sub> =50 A, V <sub>GS</sub> =0 to 10 V
Gate plateau voltage	V <sub>plateau</sub>	-	4.4	-	V	V <sub>DD</sub> =50 V, I <sub>D</sub> =50 A, V <sub>GS</sub> =0 to 10 V
Gate charge total, sync. FET	Q <sub>g(sync)</sub>	-	93	-	nC	V <sub>DS</sub> =0.1 V, V <sub>GS</sub> =0 to 10 V
Output charge <sup>1)</sup>	Qoss	-	125	166	nC	V <sub>DS</sub> =50 V, V <sub>GS</sub> =0 V

 $<sup>^{1)}</sup>$  Defined by design. Not subject to production test.  $^{2)}$  See "Gate charge waveforms" for parameter definition

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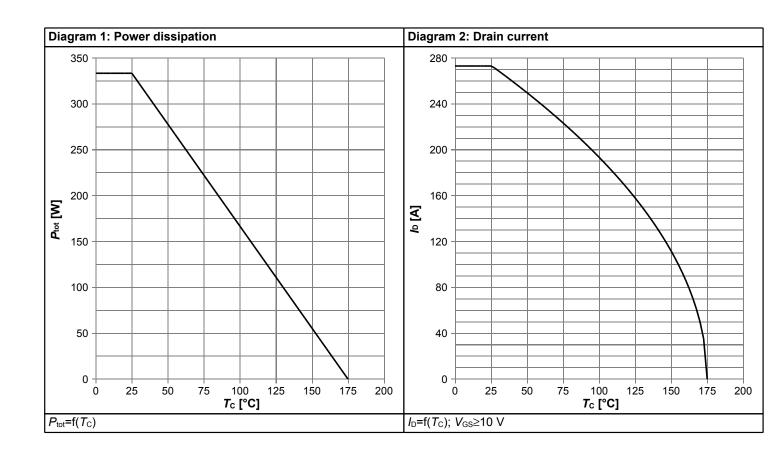


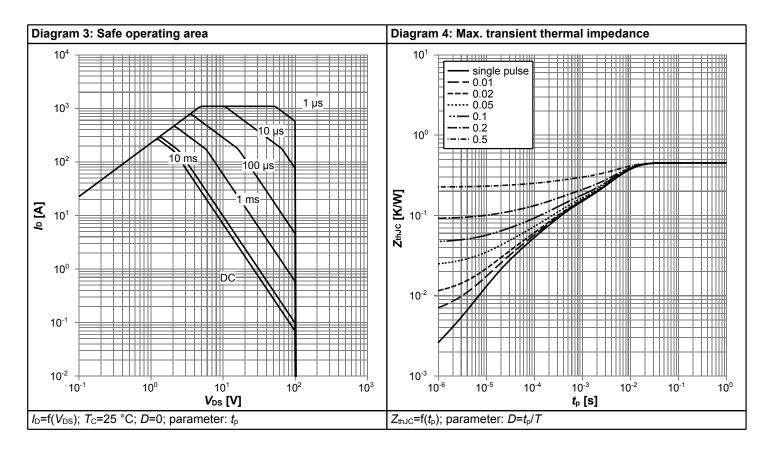
### Table 7 Reverse diode

Davamatar	Cumbal	Values			I I mit	Nata / Taat Canditian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Diode continuous forward current	Is	-	-	254	Α	T <sub>C</sub> =25 °C	
Diode pulse current	I <sub>S,pulse</sub>	-	-	1092	Α	T <sub>C</sub> =25 °C	
Diode forward voltage	V <sub>SD</sub>	-	0.82	1.0	V	V <sub>GS</sub> =0 V, I <sub>F</sub> =50 A, T <sub>j</sub> =25 °C	
Reverse recovery time <sup>1)</sup> $t_{rr}$		-	48	96	ns	V <sub>R</sub> =50 V, I <sub>F</sub> =25 A, di <sub>F</sub> /dt=100 A/μs	
Reverse recovery charge <sup>1)</sup>	Qrr	-	71	142	nC	V <sub>R</sub> =50 V, I <sub>F</sub> =25 A, d <i>i</i> <sub>F</sub> /d <i>t</i> =100 A/μs	

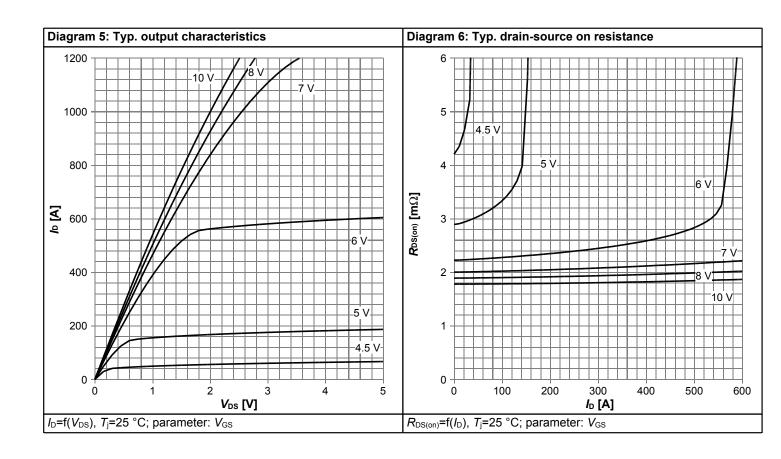


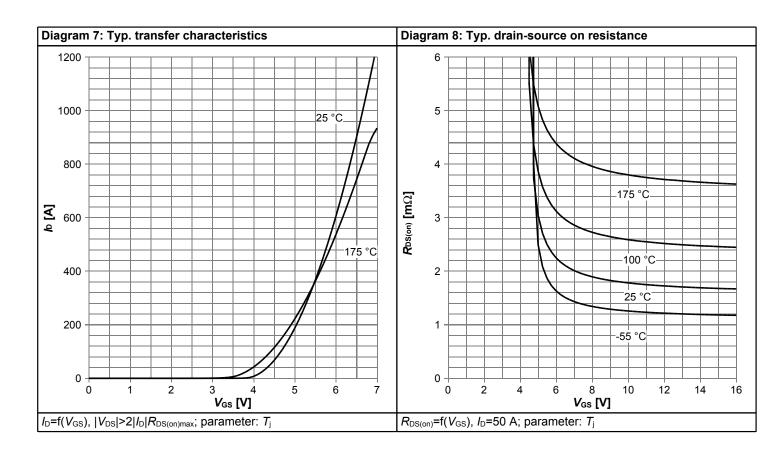
### 4 Electrical characteristics diagrams



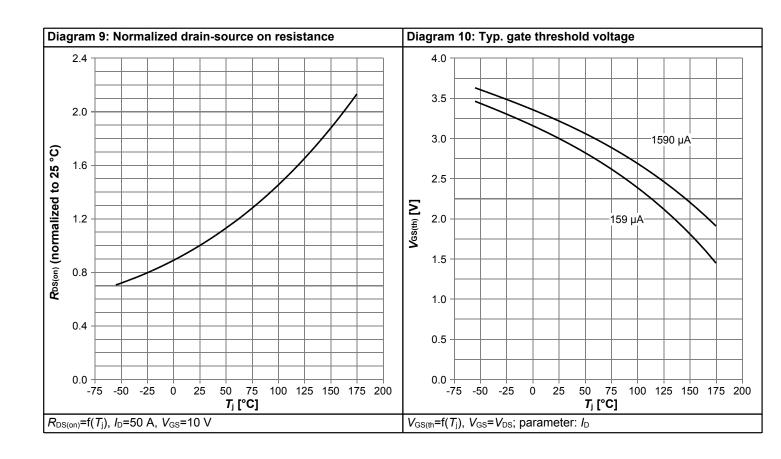


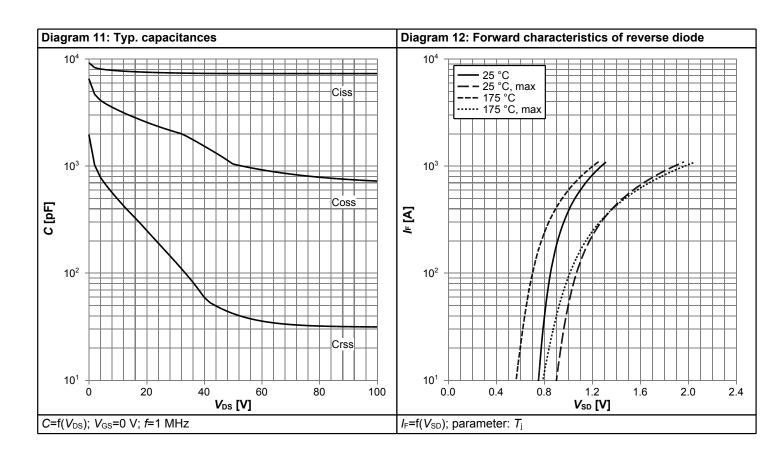




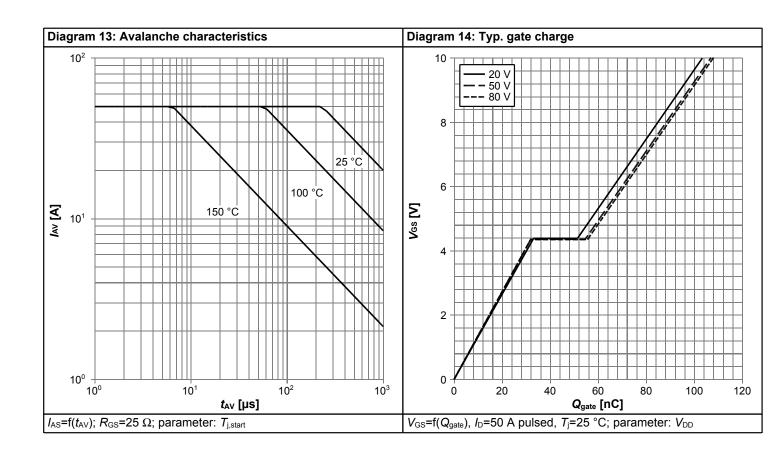


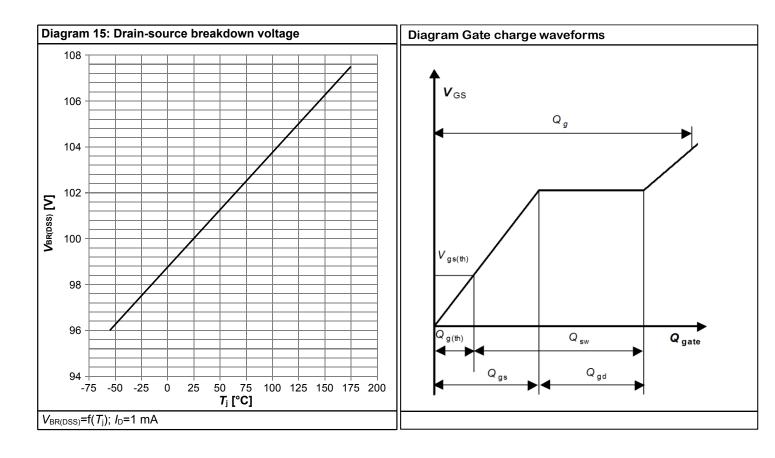














# 5 Package Outlines

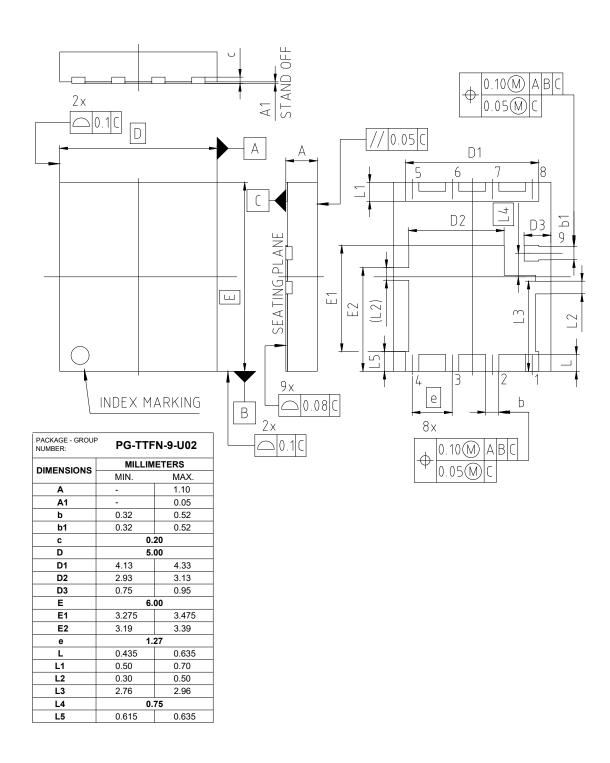


Figure 1 Outline PG-TTFN-9, dimensions in mm

# OptiMOS<sup>™</sup> 5 Power-Transistor, 100 V IQD020N10NM5CG



### **Revision History**

IQD020N10NM5CG

Revision: 2023-04-04, Rev. 2.1

Previous Revision

Torrodo Novicion							
Revision	sion Date Subjects (major changes since last revision)						
2.0	2023-03-08	Release of final version					
2.1	2023-04-04	Update RG, ext for switching times					

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